

IS680 AG -348

Very Low-Loss Laminate Materials

IS680 AG-348 laminate materials exhibit exceptional electrical properties which are very stable over a broad frequency and temperature range.

IS680 AG-348 is suitable for many of today's commercial RF/ microwave printed circuit designs. It features a dielectric constant (Dk) that is stable between -55°C and +125°C up to W-band frequencies. In addition, IS680 AG-348 offers an ultra-low dissipation factor (Df), making it an extremely cost-effective alternative to PTFE and other commercial microwave laminate materials in double sided applications.

Product Attributes

RF/Microwave

Typical Market Applications

Aerospace & Defense, RF / Microwave

ORDERING INFORMATION:

Contact your local sales representative or visit www.isola-group.com for further information.

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RF/Microwave

Data Sheet

Tg 200°C Td 360°C Dk 3.48 Df 0.0029

IPC-4103 - / 17

UL - File Number E41625

Last Updated May 8, 2019 Revision No: C

Product Features

- · Industry Recognition
 - UL File Number: E41625
 - RoHS Compliant
- · Performance Attributes
- · Processing Advantages
 - FR-4 process compatible
 - Reduced drill wear
 - No plasma desmear required
 - Consistent dielectric spacing

Product Availability

- · Standard Material Offering: Laminate
 - 60 mil (1.5mm)
 - Available in full size sheet or panel form
- · Copper Foil Type
 - VLP-2 (2 micron), 1 oz and below
- · Copper Weight
 - $\frac{1}{2}$, 1 oz (18 and 35 μ m) available
 - Heavier copper available
 - Thinner copper foil available

Property		Typical Value	Units	Test Method
			Metric (English)	IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		200	°C	2.4.25C
Decomposition Temperature (Td) by TGA @ 5% weight loss		360	°C	2.4.24.6
Time to Delaminate by TMA (Copper removed)	A. T260 B. T288	>60	Minutes	2.4.24.1
Z-Axis CTE	A. Pre-Tg B. Post-Tg C. 50 to 260°C, (Total Expansion)	44.7 191 2.9	ppm/°C ppm/°C %	2.4.24C
X/Y-Axis CTE	Pre-Tg	12	ppm/°C	2.4.24C
Thermal Conductivity		0.38 - 0.53	W/mK	ASTM E1952
Thermal Stress 10 sec @ 288ºC (550.4ºF)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	@ 10 GHz	3.48	_	2.5.5.5
Df, Loss Tangent	@ 10 GHz	0.0029	_	Bereskin Stripline
Volume Resistivity	C-96/35/90	1.33 x 10 ⁷	MΩ-cm	2.5.17.1
Surface Resistivity	C-96/35/90	1.33 x 10 ⁵	ΜΩ	2.5.17.1
Dielectric Breakdown		45.4	kV	2.5.6B
Arc Resistance		139	Seconds	2.5.1B
Electric Strength (Laminate & laminated prepreg)		45 (1133)	kV/mm (V/mil)	2.5.6.2A
Comparative Tracking Index (CTI)		2	Class (Volts)	UL 746A ASTM D3638
Peel Strength	1 oz. EDC foil	0.70 (4.01)	N/mm (lb/inch)	2.4.8.2A
Flexural Strength	A. Length direction B. Cross direction	37.5 28.5	ksi	2.4.4B
Tensile Strength	A. Length direction B. Cross direction	28.5 26.0	ksi	ASTM D3039
Poisson's Ratio	A. Length direction B. Cross direction	0.122 0.120	_	ASTM D3039
Moisture Absorption		0.10	%	2.6.2.1A
Flammability (Laminate & laminated prepreg)		V-0	Rating	UL 94
Relative Thermal Index (RTI)		130	°C	UL 796

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.



NOTE

Visit our site http://www.isola-group.com for more details. Revisions:

A: Initial release - 4/17

B: Corrected units for Flexural and Tensile Strength - 8/18

C: Change MOT to RTI 5/19